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#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

E·XFI

Product Status	Active
Core Processor	AVR
Core Size	8/16-Bit
Speed	32MHz
Connectivity	I <sup>2</sup> C, IrDA, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	34
Program Memory Size	128KB (64K x 16)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 3.6V
Data Converters	A/D 12x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	0°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VFQFN Exposed Pad
Supplier Device Package	44-VQFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atxmega128a4u-mn

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

## 15.4 Input sensing

Input sensing is synchronous or asynchronous depending on the enabled clock for the ports, and the configuration is shown in Figure 15-7.

#### Figure 15-7. Input sensing system overview.



When a pin is configured with inverted I/O, the pin value is inverted before the input sensing.

# 15.5 Alternate Port Functions

Most port pins have alternate pin functions in addition to being a general purpose I/O pin. When an alternate function is enabled, it might override the normal port pin function or pin value. This happens when other peripherals that require pins are enabled or configured to use pins. If and how a peripheral will override and use pins is described in the section for that peripheral. "Pinout and Pin Functions" on page 55 shows which modules on peripherals that enable alternate functions on a pin, and which alternate functions that are available on a pin.



# 18. AWeX – Advanced Waveform Extension

# 18.1 Features

- Waveform output with complementary output from each compare channel
- Four dead-time insertion (DTI) units
  - 8-bit resolution
  - Separate high and low side dead-time setting
  - Double buffered dead time
  - Optionally halts timer during dead-time insertion
- Pattern generation unit creating synchronised bit pattern across the port pins
  - Double buffered pattern generation
  - Optional distribution of one compare channel output across the port pins
- Event controlled fault protection for instant and predictable fault triggering

# 18.2 Overview

The advanced waveform extension (AWeX) provides extra functions to the timer/counter in waveform generation (WG) modes. It is primarily intended for use with different types of motor control and other power control applications. It enables low- and high side output with dead-time insertion and fault protection for disabling and shutting down external drivers. It can also generate a synchronized bit pattern across the port pins.

Each of the waveform generator outputs from the timer/counter 0 are split into a complimentary pair of outputs when any AWeX features are enabled. These output pairs go through a dead-time insertion (DTI) unit that generates the non-inverted low side (LS) and inverted high side (HS) of the WG output with dead-time insertion between LS and HS switching. The DTI output will override the normal port value according to the port override setting.

The pattern generation unit can be used to generate a synchronized bit pattern on the port it is connected to. In addition, the WG output from compare channel A can be distributed to and override all the port pins. When the pattern generator unit is enabled, the DTI unit is bypassed.

The fault protection unit is connected to the event system, enabling any event to trigger a fault condition that will disable the AWeX output. The event system ensures predictable and instant fault reaction, and gives flexibility in the selection of fault triggers.

The AWeX is available for TCC0. The notation of this is AWEXC.

# 26. AES and DES Crypto Engine

# 26.1 Features

- Data Encryption Standard (DES) CPU instruction
- Advanced Encryption Standard (AES) crypto module
- DES Instruction
  - Encryption and decryption
  - DES supported
  - Encryption/decryption in 16 CPU clock cycles per 8-byte block
- AES crypto module
  - Encryption and decryption
  - Supports 128-bit keys
  - Supports XOR data load mode to the state memory
  - Encryption/decryption in 375 clock cycles per 16-byte block

# 26.2 Overview

The Advanced Encryption Standard (AES) and Data Encryption Standard (DES) are two commonly used standards for cryptography. These are supported through an AES peripheral module and a DES CPU instruction, and the communication interfaces and the CPU can use these for fast, encrypted communication and secure data storage.

DES is supported by an instruction in the AVR CPU. The 8-byte key and 8-byte data blocks must be loaded into the register file, and then the DES instruction must be executed 16 times to encrypt/decrypt the data block.

The AES crypto module encrypts and decrypts 128-bit data blocks with the use of a 128-bit key. The key and data must be loaded into the key and state memory in the module before encryption/decryption is started. It takes 375 peripheral clock cycles before the encryption/decryption is done. The encrypted/encrypted data can then be read out, and an optional interrupt can be generated. The AES crypto module also has DMA support with transfer triggers when encryption/decryption is done and optional auto-start of encryption/decryption when the state memory is fully loaded.



#### 36.1.15 SPI Characteristics

MOSI

(Data output)







MSB

t<sub>MOH</sub>





t<sub>MOH</sub>

LSB

### 36.3.4 Wake-up time from sleep modes

Table 36-70.	Device wake-u	p time from slee	p modes with various	system clock sources.

Symbol	Parameter	Condition	Min.	Typ. <sup>(1)</sup>	Max.	Units
t <sub>wakeup</sub>	Wake-up time from idle, standby, and extended standby mode	External 2MHz clock		2.0		μs
		32.768kHz internal oscillator		120		
		2MHz internal oscillator		2.0		
		32MHz internal oscillator		0.2		
	Wake-up time from power-save and power-down mode	External 2MHz clock		4.5		μs
		32.768kHz internal oscillator		320		
		2MHz internal oscillator		9.0		
		32MHz internal oscillator		4.0		
Note: 1.	1. The wake-up time is the time from the wake-up request is given until the peripheral clock is available on pin, see Figure 36-16. All peripherals and modules					

1. The wake-up time is the time from the wake-up request is given until the peripheral clock is available on pin, see Figure 36-16. All peripherals and modules start execution from the first clock cycle, expect the CPU that is halted for four clock cycles before program execution starts.

#### Figure 36-16.Wake-up time definition.





### 36.3.14 Clock and Oscillator Characteristics

#### 36.3.14.1 Calibrated 32.768kHz Internal Oscillator characteristics

#### Table 36-86. 32.768kHz internal oscillator characteristics.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
	Frequency			32.768		kHz
	Factory calibration accuracy	T = 85°C, V <sub>CC</sub> = 3.0V	-0.5		0.5	%
	User calibration accuracy		-0.5		0.5	%

#### 36.3.14.2 Calibrated 2MHz RC Internal Oscillator characteristics

eristics.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
	Frequency range	DFLL can tune to this frequency over voltage and temperature	1.8		2.2	MHz
	Factory calibrated frequency			2.0		MHz
	Factory calibration accuracy	T = 85°C, V <sub>CC</sub> = 3.0V	-1.5		1.5	%
	User calibration accuracy		-0.2		0.2	%
	DFLL calibration stepsize			0.21		%

### 36.3.14.3 Calibrated and tunable 32MHz internal oscillator characteristics

#### Table 36-88. 32MHz internal oscillator characteristics.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
	Frequency range	DFLL can tune to this frequency over voltage and temperature	30		55	MHz
	Factory calibrated frequency			32		MHz
	Factory calibration accuracy	T = 85°C, V <sub>CC</sub> = 3.0V	-1.5		1.5	%
	User calibration accuracy		-0.2		0.2	%
	DFLL calibration step size			0.22		%

#### 37.1.1.3 Power-down mode supply current









Figure 37-40. DNL error vs. sample rate.



Figure 37-41. DNL error vs. input code.



Figure 37-50. DNL error vs. V<sub>REF</sub>.



Figure 37-51. DAC noise vs. temperature.  $V_{CC} = 3.0V, V_{REF} = 2.4V$ .







#### 37.2.1.2 Idle mode supply current



Frequency [MHz]









V<sub>CC</sub> [V]



Figure 37-111. I/O pin output voltage vs. source current.



Figure 37-112. I/O pin output voltage vs. sink current.  $V_{CC} = 1.8V$ .





#### 37.2.4 DAC Characteristics



Figure 37-132. Noise vs. V<sub>cc</sub>.















Figure 37-257. Active mode supply current vs.  $V_{CC}$ .  $f_{SYS} = 2MHz$  internal oscillator











#### 37.4.2.3 Thresholds and Hysteresis





Figure 37-307. Analog comparator hysteresis vs. V<sub>CC</sub>. Low power, large hysteresis



Figure 37-308. Analog comparator current source vs. calibration value. *Temperature* = 25°C



#### 37.4.10.3 2MHz Internal Oscillator













Figure 37-330. 32MHz internal oscillator CALA calibration step size  $V_{cc}$  = 3.0V



# 38. Errata

# 38.1 ATxmega16A4U

### 38.1.1 Rev. E

- ADC may have missing codes in SE unsigned mode at low temp and low Vcc
- CRC fails for Range CRC when end address is the last word address of a flash section
- AWeX fault protection restore is not done correct in Pattern Generation Mode
- ADC may have missing codes in SE unsigned mode at low temp and low Vcc The ADC may have missing codes i single ended (SE) unsigned mode below 0C when Vcc is below 1.8V.

### Problem fix/Workaround

Use the ADC in SE signed mode.

2. CRC fails for Range CRC when end address is the last word address of a flash section If boot read lock is enabled, the range CRC cannot end on the last address of the application section. If application table read lock is enabled, the range CRC cannot end on the last address before the application table.

### Problem fix/Workaround

Ensure that the end address used in Range CRC does not end at the last address before a section with read lock enabled. Instead, use the dedicated CRC commands for complete applications sections.

### 3. AWeX fault protection restore is not done correct in Pattern Generation Mode

When a fault is detected the OUTOVEN register is cleared, and when fault condition is cleared, OUTOVEN is restored according to the corresponding enabled DTI channels. For Common Waveform Channel Mode (CWCM), this has no effect as the OUTOVEN is correct after restoring from fault. For Pattern Generation Mode (PGM), OUTOVEN should instead have been restored according to the DTLSBUF register.

### Problem fix/Workaround

For CWCM no workaround is required.

For PGM in latched mode, disable the DTI channels before returning from the fault condition. Then, set correct OUTOVEN value and enable the DTI channels, before the direction (DIR) register is written to enable the correct outputs again.

## 38.1.2 Rev. A - D

Not sampled.